

PA-275711

Product Advisory

Issue Date: 29-February-2024

Change Description:

Adding SMIC Foundry site to BCM6856x Chips

Parts Affected:

BCM68560B1KFSBG-X BCM68560BB1IFSBG BCM68560B1KFSBG BCM68560B1IFSBG

Description and Extent of Change:

Addition of SMIC Foundry source

Reasons for Change:

Adding second source option for supply chain resiliency

Effect of Change on Fit, Form, Function, Quality, or Reliability:

All electrical specifications and physical characteristics remain within the datasheet limits. Appropriate electrical characterization and reliability qualifications have been performed on representative products to ensure normal parametric distribution, consistent electrical performance, and reliability

Effective Date of Change:

Product shipments using this change will begin 7/01/2024

Qualification Data:

Provided upon request.

Samples are available upon request

Software / Firmware Update:

No Software or Firmware changes are expected with this addition

Please contact your Broadcom field sales engineer or Contact Center for any questions or support requirements. Please acknowledge the receipt of the notice within 30 days of delivery. Lack of acknowledgement within 30 days constitutes acceptance of the change per JEDEC J-STD-046.